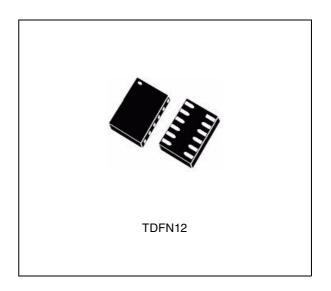


# STM6600 STM6601

# Smart push-button on/off controller with Smart Reset<sup>TM</sup> and power-on lockout

#### **Features**

- Operating voltage 1.6 V to 5.5 V
- Low standby current of 1 µA
- Adjustable Smart Reset<sup>™</sup> assertion delay time driven by external C<sub>SRD</sub>
- Power-up duration determined primarily by push-button press (STM6600) or by fixed time period, t<sub>ON BLANK</sub> (STM6601)
- Debounced PB and SR inputs
- PB and SR ESD inputs withstand voltage up to ±15 kV (air discharge) ±8 kV (contact discharge)
- Active high or active low enable output option (EN or EN) provides control of MOSFET, DC-DC converter, regulator, etc.
- Secure startup, interrupt, Smart Reset<sup>™</sup> or power down driven by push-button
- Precise 1.5 V voltage reference with 1% accuracy
- Industrial operating temperature –40 to +85 °C
- Available in TDFN12 2 x 3 mm package



## **Applications**

- Portable devices
- Terminals
- Audio and video players
- Cell phones and smart phones
- PDAs, palmtops, organizers

Table 1.	Device	summarv

Device	RST	C <sub>SRD</sub>	PB/SR	EN or EN	ĪNT	Startup process
STM6600	open drain <sup>(1)</sup>	<b>&gt;</b>	<b>✓</b>	push-pull	open drain <sup>(1)</sup>	PB must be held low until the PS <sub>HOLD</sub> <sup>(2)</sup> confirmation
STM6601	open drain <sup>(1)</sup>	1	/	push-pull	open drain <sup>(1)</sup>	PB can be released before the PS <sub>HOLD</sub> (2) confirmation

- 1. External pull-up resistor needs to be connected to open drain outputs.
- 2. For a successful startup, the PS<sub>HOLD</sub> (Power Supply Hold) needs to be pulled high within specific time, t<sub>ON\_BLANK</sub>.

Contents STM6600 - STM6601

# **Contents**

1	Description
2	Pin descriptions9
3	Operation
4	Waveforms
5	Typical operating characteristics
6	Maximum ratings
7	DC and AC characteristics 39
8	Package mechanical data 42
9	Part numbering
10	Product selector 48
11	Revision history

STM6600 - STM6601 List of tables

# **List of tables**

Table 1.	Device summary	. 1
Table 2.	Pin descriptions	. 7
Table 3.	Absolute maximum ratings	38
Table 4.	Operating and AC measurement conditions	39
Table 5.	DC and AC characteristics	39
Table 6.	TDFN12 (2 x 3 mm) package mechanical data	43
Table 7.	Carrier tape dimensions for TDFN12 (2 mm x 3 mm) package	45
Table 8.	STM6600 ordering information scheme	46
Table 9.	STM6601 ordering information scheme	47
Table 10.	STM6600 product selector	48
Table 11.	STM6601 product selector	49
Table 12.	Document revision history	50

List of figures STM6600 - STM6601

# **List of figures**

Figure 1.	Application hookup	5
Figure 2.	Basic functionality (option with enable deassertion after long push)	6
Figure 3.	Basic functionality (option with RST assertion after long push)	6
Figure 4.	Logic diagram	6
Figure 5.	TDFN12 pin connections	7
Figure 6.	Block diagram	8
Figure 7.	Successful power-up on STM6600	
	(PB released prior to t <sub>ON BLANK</sub> expiration)	14
Figure 8.	Successful power-up on STM6600	
	(t <sub>ON BLANK</sub> expires prior to PB release)	15
Figure 9.	Unsuccessful power-up on STM6600	
	(PB released prior to t <sub>ON BLANK</sub> )	16
Figure 10.	Unsuccessful power-up on STM6600	
	(t <sub>ON BLANK</sub> expires prior to $\overline{PB}$ release)	17
Figure 11.	Successful power-up on STM6601	18
Figure 12.	Unsuccessful power-up on STM6601 · · · · · · · · · · · · · · · · · · ·	19
Figure 13.	Power-up on STM660x with voltage dropout	20
Figure 14.	PB interrupt	21
Figure 15.	Long push, PB pressed first	
Figure 16.	Long push, SR pressed first	
Figure 17.	Invalid long push	
Figure 18.	Long push (option with RST assertion)	
Figure 19.	Long push (option with enable deassertion)	
Figure 20.	Undervoltage detected for <t<sub>SRD</t<sub>	
Figure 21.	Undervoltage detected for >t <sub>SRD</sub>	
Figure 22.	PB <sub>OUT</sub> output waveform	
Figure 23.	Supply current vs. temperature, normal state	
Figure 24.	Supply current vs. temperature, standby state	
Figure 25.	Supply current vs. supply voltage, normal state	
Figure 26.	Supply current vs. supply voltage, standby state	
Figure 27.	Threshold vs. temperature, V <sub>TH+</sub> = 3.4 V (typ.)	
Figure 28.	Threshold hysteresis vs. temperature, V <sub>HYST</sub> = 200 mV (typ.)	
Figure 29.	Debounce period vs. supply voltage	
Figure 30.	$C_{SRD}$ charging current vs. temperature, $V_{CC} = 3.6 \text{ V} \dots$	31
Figure 31.	Output low voltage vs. output low current, T <sub>A</sub> = 25°C	32
Figure 32.	Output high voltage vs. output high current, T <sub>A</sub> = 25°C	
Figure 33.	Output voltage vs. supply voltage, I <sub>OUT</sub> = 1 mA, T <sub>A</sub> = 25 °C	
Figure 34.	Input voltage vs. temperature	33
Figure 35.	Reference output voltage vs. temperature, V <sub>CC</sub> = 2.0 V	34
Figure 36.	Reference output voltage vs. load current, V <sub>CC</sub> = 2.0 V, T <sub>A</sub> = 25 °C	34
Figure 37.	Reference output voltage vs. supply voltage, I <sub>A</sub> = 25 °C	35
Figure 38.	Reference startup, $I_{REF} = 15 \mu F$ , $T_A = 25 °C$	35
Figure 39.	Reference response to steps on supply voltage, $I_{REF}$ = 15 $\mu$ A, $T_A$ = 25 $^{\circ}$ C	36
Figure 40.	Reference response to steps in load current, $V_{CC} = 3.6 \text{ V}$ , $T_A = 25 ^{\circ}\text{C}$	
Figure 41.	TDFN12 (2 x 3 mm) package outline	
Figure 42.	TDFN12 (2 x 3 mm) recommended footprint	
Figure 43.	Carrier tape for TDFN12 (2 mm x 3 mm) package	45

577

STM6600 - STM6601 Description

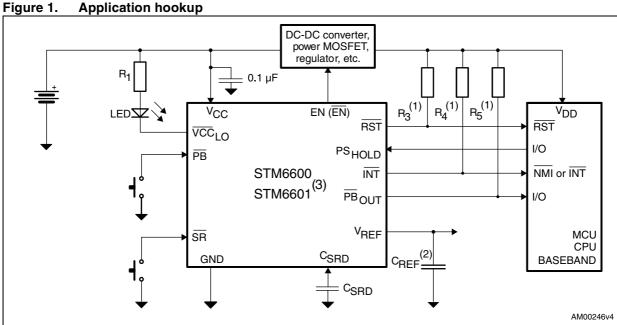
# 1 Description

The STM6600-01 devices monitor the state of connected push-button(s) as well as sufficient supply voltage. An enable output controls power for the application through the MOSFET transistor, DC-DC converter, regulator, etc. If the supply voltage is above a precise voltage threshold, the enable output can be asserted by a simple press of the button. Factory-selectable supply voltage thresholds are determined by highly accurate and temperature-compensated references. An interrupt is asserted by pressing the push-button during normal operation and can be used to request a system power-down. The interrupt is also asserted if undervoltage is detected. By a long push of one button  $(\overline{PB})$  or two buttons  $(\overline{PB})$  and  $\overline{SR})$  either a reset is asserted or power for the application is disabled depending on the option used.

The device also offers additional features such as precise 1.5 V voltage reference with very tight accuracy of 1%, separate output indicating undervoltage detection and separate output for distinguishing between interrupt by push-button or undervoltage.

The device consumes very low current of 6  $\mu A$  during normal operation and only 1  $\mu A$  current during standby.

The STM6600-01 is available in the TDFN12 package and is offered in several options among features such as selectable threshold, hysteresis, timeouts, output types, etc. (see *Table 8* and *Table 9* for more information).



- A resistor is required for open drain output type only. A 10 kΩ pull-up is sufficient in most applications.
- 2. Capacitor C<sub>REF</sub> is mandatory on V<sub>REF</sub> output (even if V<sub>REF</sub> is not used). Capacitor value of 1 μF is recommended.
- 3. For the STM6601 the processor has to confirm the proper power-on during the fixed time period, t<sub>ON\_BLANK</sub>. This failsafe feature prevents the user from turning on the system when there is a faulty power switch or an unresponsive microprocessor.

**Description** STM6600 - STM6601

INTERRUPT POWER DOWN POWER-UP(1) (short push) (long push) PB SR ΕN INT interrupt interrupt AM00243v1

Figure 2. Basic functionality (option with enable deassertion after long push)

1. For power-up the battery voltage has to be above  $V_{TH+}$  threshold.

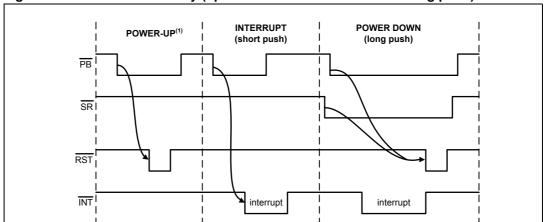


Figure 3. Basic functionality (option with RST assertion after long push)

1. For power-up the battery voltage has to be above  $V_{TH+}$  threshold.

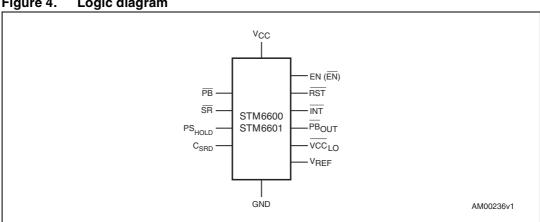


Figure 4. Logic diagram

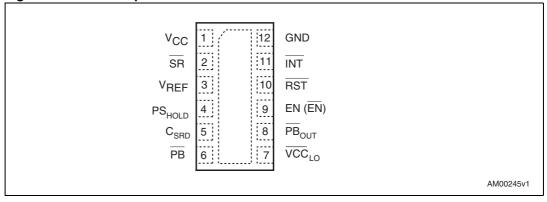
AM00243bv1

STM6600 - STM6601 Description

Table 2. Pin descriptions

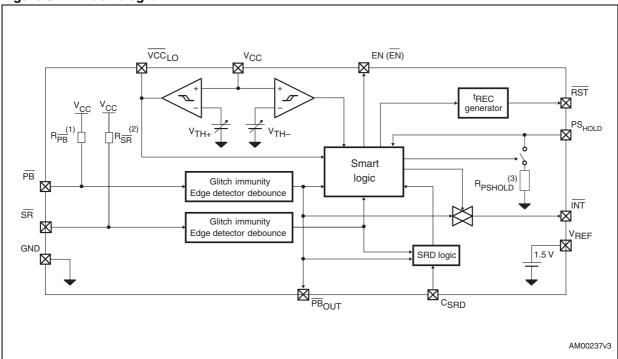
Pin number	Symbol	Function	
1	$V_{CC}$	Power supply input	
2	SR	Smart Reset <sup>™</sup> button input	
3	V <sub>REF</sub>	Precise 1.5 V voltage reference	
4	PS <sub>HOLD</sub>	PS <sub>HOLD</sub> input	
5	C <sub>SRD</sub>	Adjustable Smart Reset <sup>™</sup> delay time input	
6	PB	Push-button input	
7	VCC <sub>LO</sub>	Output for high threshold comparator output (V <sub>TH+</sub> )	
8	PB <sub>OUT</sub>	Status of PB push-button input	
9	EN or EN	Enable output	
10	RST	Reset output	
11	ĪNT	Interrupt output	
12	GND	Ground	

Figure 5. TDFN12 pin connections



Description STM6600 - STM6601

Figure 6. Block diagram



- 1. Internal pull-up resistor connected to  $\overline{PB}$  input (see *Table 5* for precise specifications).
- 2. Optional internal pull-up resistor connected to \$\overline{SR}\$ input (see \$Table 5\$ for precise specifications and \$Table 10\$ for detailed device options).
- 3. Internal pull-down resistor is connected to PS<sub>HOLD</sub> input only during startup (see Figure 7, 8, 9, 10, 11, 12, 13, and 18).

STM6600 - STM6601 Pin descriptions

# 2 Pin descriptions

#### V<sub>CC</sub> - power supply input

 $V_{CC}$  is monitored during startup and normal operation for sufficient voltage level. Decouple the  $V_{CC}$  pin from ground by placing a 0.1  $\mu$ F capacitor as close to the device as possible.

#### SR - Smart Reset<sup>™</sup> button input

This input is equipped with voltage detector with a factory-trimmed threshold and has  $\pm 8$  kV HBM ESD protection.

Both  $\overline{PB}$  and  $\overline{SR}$  buttons have to be pressed and held for  $t_{SRD}$  period so the long push is recognized and the reset is asserted (or the enable output is deasserted depending on the option) - see *Figure 15*, *16*, and *17*.

Active low  $\overline{SR}$  input is usually connected to GND through the momentary push-button (see *Figure 1*) and it has an optional 100 k $\Omega$  pull-up resistor. It is also possible to drive this input using an external device with either open drain (recommended) or push-pull output. Open drain output can be connected in parallel with push-button or other open drain outputs, which is not possible with push-pull output.

#### V<sub>REF</sub> - external precise 1.5 V voltage reference

This 1.5 V voltage reference is specified with very tight accuracy of 1% (see *Table 5*). It has proper output voltage as soon as the reset output is deasserted (i.e. after  $t_{REC}$  expires) and it is disabled when the device enters standby mode. A mandatory capacitor needs to be connected to  $V_{REF}$  output (even if  $V_{REF}$  is not used). Capacitor value of 1  $\mu F$  is recommended.

#### **PS<sub>HOLD</sub>** input

This input is equipped with a voltage detector with a factory-trimmed threshold. It is used to confirm correct power-up of the device (if EN or  $\overline{\text{EN}}$  is not asserted) or to initiate a shutdown (if EN or  $\overline{\text{EN}}$  is asserted).

Forcing PS<sub>HOLD</sub> high during power-up confirms the proper start of the application and keeps enable output asserted. Because most processors have outputs in high-Z state before initialization, an internal pull-down resistor is connected to PS<sub>HOLD</sub> input during startup (see *Figure 7, 8, 9, 10, 11, 12, 13,* and *18*).

Forcing the PS<sub>HOLD</sub> signal low during normal operation deasserts the enable output (see *Figure 14*). Input voltage on this pin is compared to an accurate voltage reference.

#### C<sub>SRD</sub> - Smart Reset<sup>™</sup>delay time input

A capacitor to ground determines the additional time ( $t_{SRD}$ ) that  $\overline{PB}$  with  $\overline{SR}$  must be pressed and held before a long push is recognized. The connected  $C_{SRD}$  capacitor is charged with  $I_{SRD}$  current. Additional Smart Reset delay time  $t_{SRD}$  ends when voltage on the  $C_{SRD}$  capacitor reaches the  $V_{SRD}$  voltage threshold. It is recommended to use a low ESR capacitor (e.g. ceramic). If the capacitor is not used, leave the  $C_{SRD}$  pin open. If no capacitor is connected, there is no  $t_{SRD}$  and a long push is recognized right after  $t_{\overline{INT}\_Min}$  expires (see *Figure 18* and *19*).

Pin descriptions STM6600 - STM6601

#### PB - power ON switch

This input is equipped with a voltage detector with a factory-trimmed threshold and has  $\pm$  8 kV HBM ESD protection.

When the  $\overline{PB}$  button is pressed and held, the battery voltage is detected and EN (or  $\overline{EN}$ ) is asserted if the battery voltage is above the threshold  $V_{TH+}$  during the whole  $t_{DEBOUNCE}$  period (see *Figure 13*).

A short push of the push-button during normal operation can initiate an interrupt through debounced  $\overline{\text{INT}}$  output (see *Figure 14*) and a long push of  $\overline{\text{PB}}$  and  $\overline{\text{SR}}$  simultaneously can either assert reset output  $\overline{\text{RST}}$  (see *Figure 18*) or deassert the EN or  $\overline{\text{EN}}$  output (see *Figure 19*) based on the option used.

Note:

A switch to GND must be connected to this input (e.g. mechanical push-button, open drain output of external circuitry, etc.), see Figure 1. This ensures a proper startup signal on  $\overline{PB}$  (i.e. a transition from full  $V_{CC}$  below specified  $V_{IL}$ ).  $\overline{PB}$  input has an internal 100 k $\Omega$  pull-up resistor connected.

#### VCC<sub>LO</sub> - high threshold detection output

During power-up,  $\overline{VCC}_{LO}$  is low when  $V_{CC}$  supply voltage is below the  $V_{TH+}$  threshold. After successful power-up (i.e. during normal operation)  $\overline{VCC}_{LO}$  is low anytime undervoltage is detected (see *Figure 13*).

Output type is active low and open drain by default. Open drain output type requires a pull-up resistor. A 10  $k\Omega$  is sufficient in most applications.

VCC<sub>I O</sub> is floating when STM660x is in standby mode.

#### PBOUT - PB input state

If the push-button  $\overline{PB}$  is pressed, the pin stays low during the  $t_{DEBOUNCE}$  time period. If  $\overline{PB}$  is asserted for the entire  $t_{DEBOUNCE}$  period,  $\overline{PB}_{OUT}$  will then stay low for at least  $t_{\overline{INT}\_Min}$ . If  $\overline{PB}$  is asserted after  $t_{\overline{INT}\_Min}$  expires,  $\overline{PB}_{OUT}$  will return high as soon as  $\overline{PB}$  is deasserted (see Figure 22).  $\overline{PB}_{OUT}$  ignores  $\overline{PB}$  assertion during an undervoltage condition. At startup on the STM6601  $\overline{PB}_{OUT}$  will respond only to the first  $\overline{PB}$  assertion and any other assertion will be ignored until  $t_{ON\_BLANK}$  expires. This output is active low and open drain by default. Open drain output type requires a pull-up resistor. A 10 k $\Omega$  is sufficient in most applications.



STM6600 - STM6601 Pin descriptions

#### EN or EN - enable output

This output is intended to enable system power (see *Figure 1*). EN is asserted **high** after a valid turn-on event has been detected and confirmed (i.e. push-button has been pressed and held for  $t_{DEBOUNCE}$  or more and  $V_{CC} > V_{TH+}$  voltage level has been detected - see *Figure 13*). EN is released **low** if any of the conditions below occur:

- a) the push-button is released before PS<sub>HOLD</sub> is driven high (valid for STM6600, see Figure 9) or t<sub>ON\_BLANK</sub> expires before PS<sub>HOLD</sub> is driven high during startup (valid for both STM6600 and STM6601, see Figure 10 and 12).
- b) PS<sub>HOLD</sub> is driven low during normal operation (see *Figure 14*).
- an undervoltage condition is detected for more than  $t_{SRD} + t_{\overline{INT}\_Min} + t_{DEBOUNCE}$  (see *Figure 21*).
- d) a long push of the buttons is detected (only for the device with option "EN deasserted by long push" see *Figure 19*) or PS<sub>HOLD</sub> is not driven high during t<sub>ON\_BLANK</sub> after a long push of the buttons (only for the device with option "RST asserted by long push" see *Figure 18*).

Described logic levels are inverted in case of EN output. Output type is push-pull by default.

#### RST - reset output

This output pulls low for t<sub>BFC</sub>:

- a) during startup. PB has been pressed (falling edge on the PB detected) and held for at least t<sub>DEBOUNCE</sub> and V<sub>CC</sub> > V<sub>TH+</sub> (see Figure 7, 8, 9, 10, 11, 12 and 13 for more details).
- b) after long push detection (valid only for the device with option "RST asserted by long push"). PB has been pressed (falling edge on the PB detected) and held for more than t<sub>DEBOUNCE</sub> + t<sub>SRD</sub> (additional Smart Reset<sup>™</sup> delay time can be adjusted by the external capacitor C<sub>SRD</sub>) see *Figure 18*.

Output type is active low and open drain by default. Open drain output type requires a pull-up resistor. A 10  $k\Omega$  is sufficient in most applications.

#### **INT** - interrupt output

While the system is under normal operation ( $PS_{HOLD}$  is driven high, power for application is asserted), the  $\overline{INT}$  is driven **low** if:

- a) V<sub>CC</sub> falls below V<sub>TH</sub>- threshold (i.e. undervoltage is detected see *Figure 20* and 21).
- b) the falling edge on the  $\overline{PB}$  is detected and the push-button is held for  $t_{DEBOUNCE}$  or more.  $\overline{INT}$  is driven low after  $t_{DEBOUNCE}$  and stays low as long as  $\overline{PB}$  is held. The  $\overline{INT}$  signal is held high during power-up.

The state of the  $\overline{PB}_{OUT}$  output can be used to determine if the interrupt was caused by either the assertion of the  $\overline{PB}$  input, or was due to the detection of an undervoltage condition on  $V_{CC}$ .

INT output is asserted low for at least tint Min.

Output type is active low and open drain by default. Open drain output type requires a pull-up resistor. A 10  $k\Omega$  is sufficient in most applications.

#### **GND** - ground

Operation STM6600 - STM6601

# 3 Operation

The STM6600-STM6601 simplified smart push-button on/off controller with Smart Reset<sup>™</sup> and power-on lockout enables and disables power for the application depending on push-button states, signals from the processor, and battery voltage.

#### Power-on

Because most of the processors have outputs in high-Z state before initialization, an internal pull-down resistor is connected to PS<sub>HOLD</sub> input during startup (see *Figure 7*, *8*, *9*, *10*, *11*, *12*, *13*, and *18*).

To power up the device the push-button  $\overline{PB}$  has to be pressed for at least  $t_{DEBOUNCE}$  and  $V_{CC}$  has to be above  $V_{TH+}$  for the whole  $t_{DEBOUNCE}$  period. If the battery voltage drops below  $V_{TH+}$  during the  $t_{DEBOUNCE}$ , the counter is reset and starts to count again when  $V_{CC} > V_{TH+}$  (see *Figure 13*). After  $t_{DEBOUNCE}$  the enable signal is asserted (EN goes high,  $\overline{EN}$  goes low), reset output  $\overline{RST}$  is asserted for  $t_{REC}$  and then the startup routine is performed by the processor. During initialization, the processor sets the  $PS_{HOLD}$  signal high.

On the STM6600 the  $PS_{HOLD}$  signal has to be set high prior to push-button release and  $t_{ON\_BLANK}$  expiration, otherwise the enable signal is deasserted (EN goes low,  $\overline{EN}$  goes high) - see *Figure 7*, 8, 9, and 10. The time up to push-button release represents the maximum time allowed for the system to power up and initialize the circuits driving the  $PS_{HOLD}$  input. If the  $PS_{HOLD}$  signal is low at push-button release, the enable output is deasserted immediately, thus turning off the system power. If  $t_{ON\_BLANK}$  expires prior to push-button release, the  $PS_{HOLD}$  state is checked at its expiration. This safety feature disables the power and prevents discharging the battery if the push-button is stuck or it is held for an unreasonable period of time and the application is not responding (see *Figure 8* and 10).  $\overline{PB}$  status,  $\overline{INT}$  status and  $V_{CC}$  undervoltage detection are not monitored until power-up is completed.

On the STM6601 the PS<sub>HOLD</sub> signal has to be set high before  $t_{ON\_BLANK}$  expires, otherwise the enable signal is deasserted - see *Figure 11* and *12*. In this case the  $t_{ON\_BLANK}$  period is the maximum time allowed for the power switch and processor to perform the proper power-on. If the PS<sub>HOLD</sub> signal is low at the end of the blanking period, the enable output is released immediately, thus turning off the system power.  $\overline{PB}$  status,  $\overline{INT}$  status and  $V_{CC}$  undervoltage detection are not monitored during the entire  $t_{ON\_BLANK}$  period. This failsafe feature prevents the user from turning on the system when there is a faulty power switch or an unresponsive microprocessor.

#### **Push-button interrupt**

If the device works under normal operation (i.e.  $PS_{HOLD}$  is high) and the push-button  $\overline{PB}$  is pressed for more than  $t_{DEBOUNCE}$ , a negative pulse with minimum  $t_{\overline{INT}\_Min}$  width is generated on the  $\overline{INT}$  output. By connecting  $\overline{INT}$  to the processor interrupt input ( $\overline{INT}$  or  $\overline{NMI}$ ) a safeguard routine can be performed and the power can be shut down by setting  $PS_{HOLD}$  low - see *Figure 14*.

#### Forced power-down mode

The PS<sub>HOLD</sub> output can be forced low anytime during normal operation by the processor and can deassert the enable signal - see *Figure 14*.

STM6600 - STM6601 Operation

#### **Undervoltage detection**

If  $V_{CC}$  voltage drops below  $V_{TH}$  voltage threshold during normal operation, the  $\overline{INT}$  output is driven low (see *Figure 20* and *Figure 21*).

If an undervoltage condition is detected for  $t_{DEBOUNCE} + t_{\overline{INT}\_Min} + t_{SRD}$ , the enable output is deasserted (see *Figure 21*).

#### Hardware reset or power-down while system not responding

If the system is not responding and the system hangs, the  $\overline{PB}$  and  $\overline{SR}$  push-buttons can be pressed simultaneously longer than  $t_{DEBOUNCE}+t_{\overline{INT}\ Min}+t_{SRD}$ , and then

- a) either the reset output  $\overline{\mathsf{RST}}$  is asserted for  $\mathsf{t}_{\mathsf{REC}}$  and the processor is reset (valid only for the device with option " $\overline{\mathsf{RST}}$  asserted by long push") see Figure 18
- b) or the power is disabled by EN or  $\overline{\text{EN}}$  signal (valid only for the device with option "EN deasserted by long push") see *Figure 19*

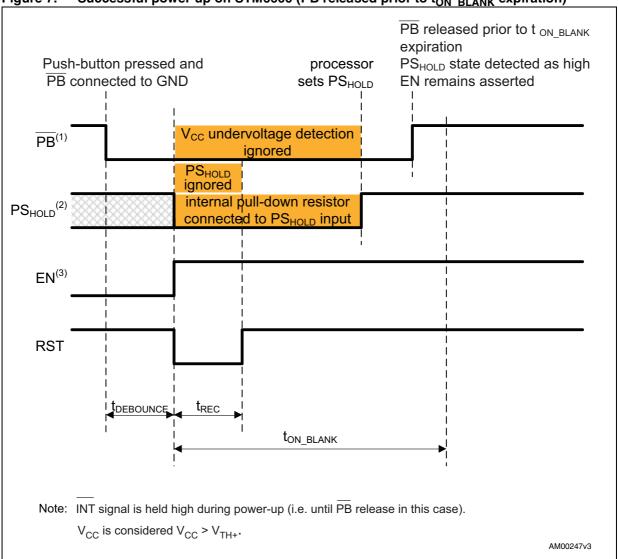
The t<sub>SRD</sub> is set by the external capacitor connected to the C<sub>SRD</sub> pin.

#### Standby

If the enable output is deasserted (i.e. EN is low or  $\overline{\text{EN}}$  is high), the STM660x device enters standby mode with low current consumption (see *Table 5*). In standby mode  $\overline{\text{PB}}$  input is only monitored for the falling edge. The external 1.5 V voltage reference is also disabled in standby mode.

## 4 Waveforms





- 1.  $\overline{PB}$  detection on falling and rising edges.
- 2. Internal pull-down resistor 300 k $\!\Omega$  is connected to PS  $_{\!HOLD}$  input during power-up.
- 3. EN signal is high even after  $\overline{PB}$  release, because processor sets  $PS_{HOLD}$  signal high before  $\overline{PB}$  is released.

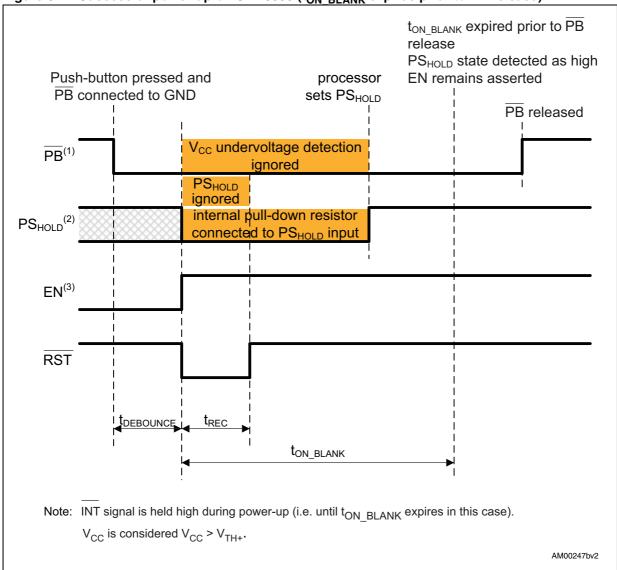


Figure 8. Successful power-up on STM6600 (t<sub>ON BLANK</sub> expires prior to PB release)

<sup>1.</sup> PB detection on falling and rising edges.

<sup>2.</sup> Internal pull-down resistor 300 k $\!\Omega$  is connected to PS  $_{\!HOLD}$  input during power-up.

<sup>3.</sup>  $t_{ON\ BLANK}$  expires prior to  $\overline{PB}$  release so  $PS_{HOLD}$  is checked at its expiration.

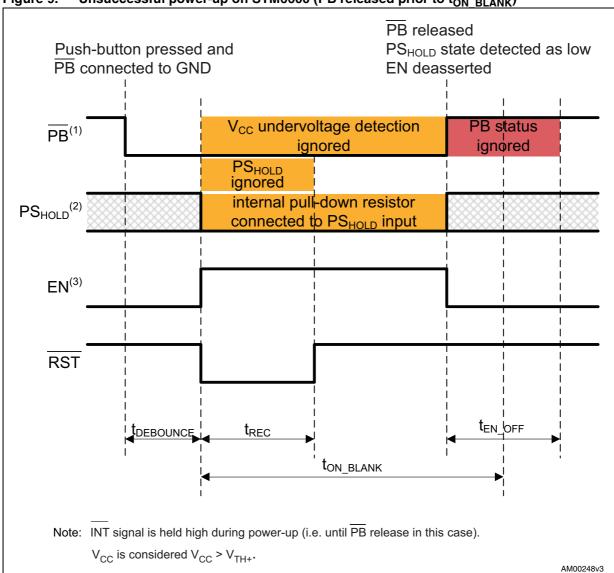


Figure 9. Unsuccessful power-up on STM6600 (PB released prior to ton BLANK)

- 1. PB detection on falling and rising edges.
- 2. Internal pull-down resistor 300 k $\Omega$  is connected to PS<sub>HOLD</sub> input during power-up.
- 3. EN signal goes low with  $\overline{PB}$  release, because processor did not force PS $_{HOLD}$  signal high.

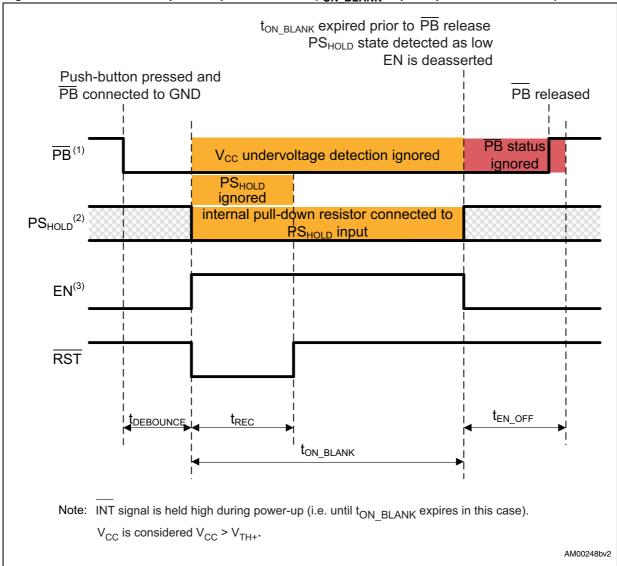
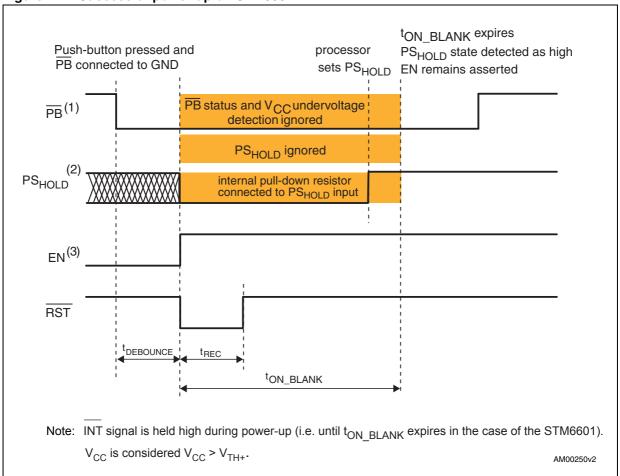


Figure 10. Unsuccessful power-up on STM6600 (ton Blank expires prior to PB release)

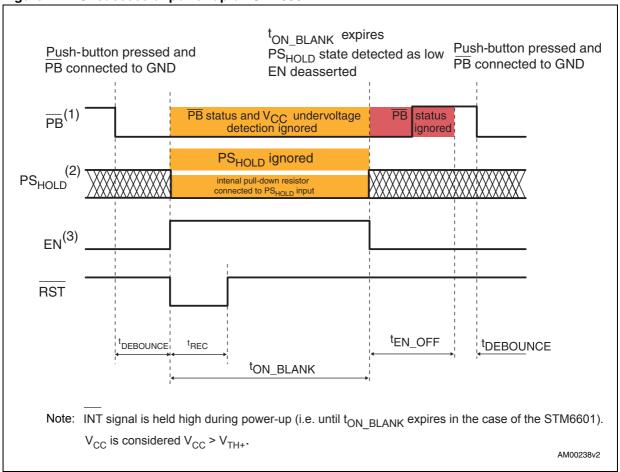
- 1. PB detection on falling and rising edges.
- 2. Internal pull-down resistor 300 k $\Omega$  is connected to PS  $_{\mbox{\scriptsize HOLD}}$  input during power-up.
- 3.  $t_{ON\ BLANK}$  expires prior to  $\overline{PB}$  release so  $PS_{HOLD}$  is checked at its expiration.

Figure 11. Successful power-up on STM6601



- 1. PB detection on falling edge.
- 2. Internal pull-down resistor 300 k $\Omega$  is connected to PS<sub>HOLD</sub> input during power-up.
- 3. PS<sub>HOLD</sub> signal is ignored during t<sub>ON\_BLANK</sub>. When t<sub>ON\_BLANK</sub> expires, the level of the PS<sub>HOLD</sub> signal is high therefore the EN signal remains asserted.





- 1. PB detection on falling edge.
- 2. Internal pull-down resistor 300 k $\Omega$  is connected to PS  $_{\mbox{\scriptsize HOLD}}$  input during power-up.
- 3. PS<sub>HOLD</sub> signal is ignored during t<sub>ON\_BLANK</sub>. When t<sub>ON\_BLANK</sub> expires, the level of the PS<sub>HOLD</sub> signal is not high therefore the EN signal goes low. Even releasing the PB button after the t<sub>ON\_BLANK</sub> will not prevent this.

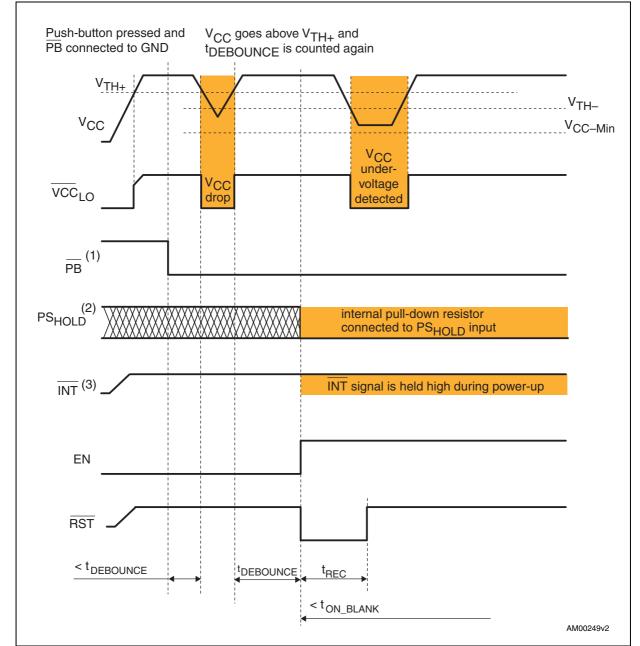
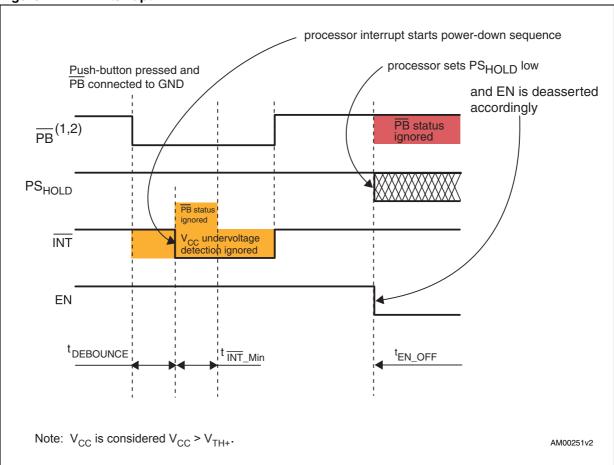


Figure 13. Power-up on STM660x with voltage dropout

- 1.  $\overline{PB}$  detection on falling and rising edges.
- 2. Internal pull-down resistor 300  $k\Omega$  is connected to  $\text{PS}_{\text{HOLD}}$  input during power-up.
- 3.  $\overline{\text{INT}}$  signal is held high during power-up.

Figure 14. PB interrupt



- 1. PB detection on falling edge.
- 2.  $\overline{PB}$  is released within  $t_{SRD}$  and that is why NO reset is asserted and EN is NOT deasserted immediately.

Figure 15. Long push, PB pressed first

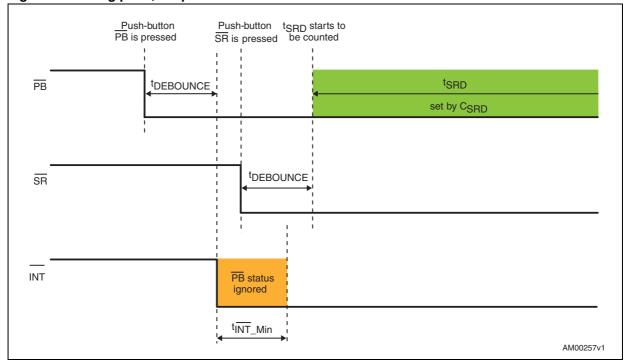


Figure 16. Long push, SR pressed first

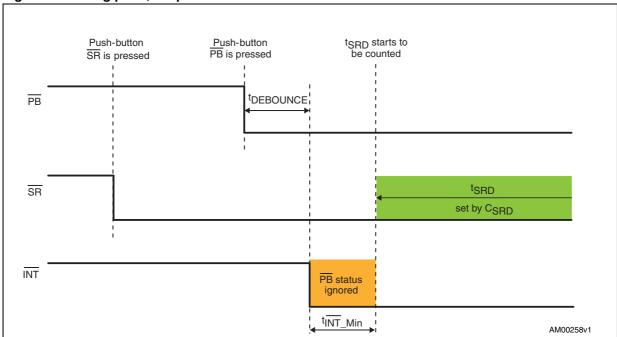
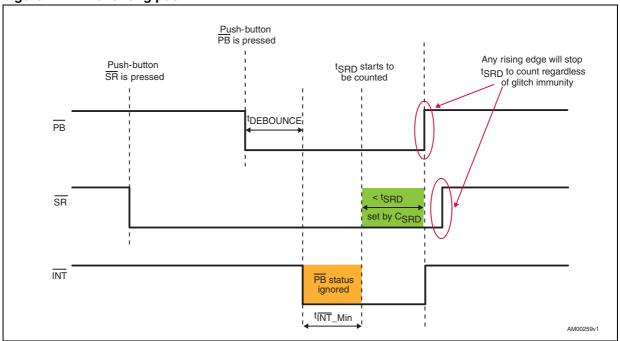


Figure 17. Invalid long push



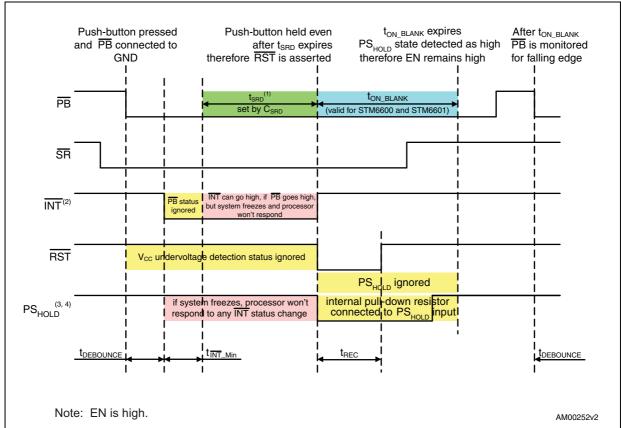


Figure 18. Long push (option with RST assertion)

- 1. t<sub>SRD</sub> period is set by external capacitor C<sub>SRD</sub>.
- 2.  $\overline{PB}$  ignored during  $t_{\overline{INT}\_{Min}}$ .
- PS<sub>HOLD</sub> signal is ignored during t<sub>ON\_BLANK</sub>. Its level is checked after t<sub>ON\_BLANK</sub> expires and if it is high the EN signal remains asserted, otherwise EN goes low.
- 4. Internal pull-down resistor 300 k $\Omega$  is connected to PS<sub>HOLD</sub> input during startup when device is reset.

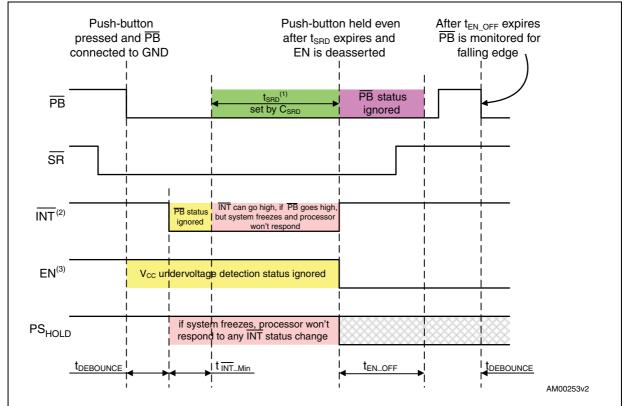
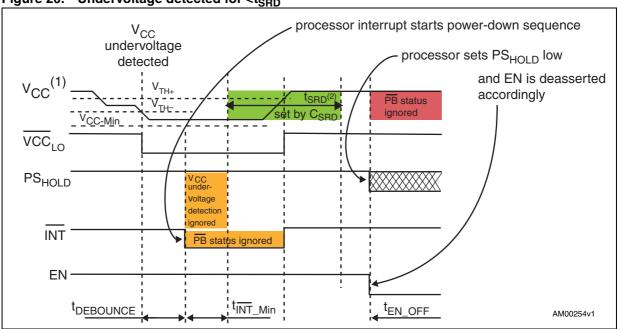


Figure 19. Long push (option with enable deassertion)

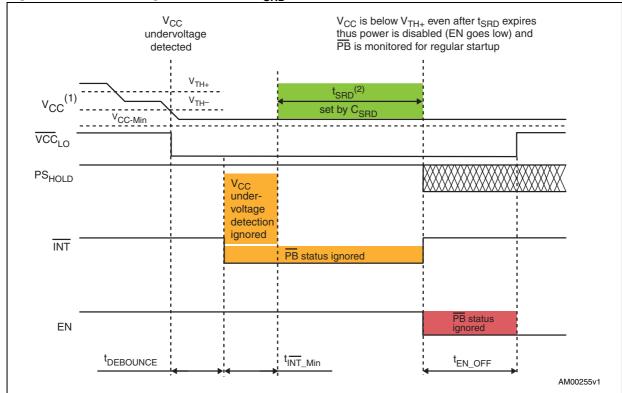
- 1.  $t_{SRD}$  period is set by external capacitor  $C_{SRD}$ .
- 2.  $\overline{PB}$  ignored during  $t_{\overline{INT}\_{Min}}$ .
- 3. After t<sub>SRD</sub> expires EN is forced low.

Figure 20. Undervoltage detected for <t<sub>SRD</sub>



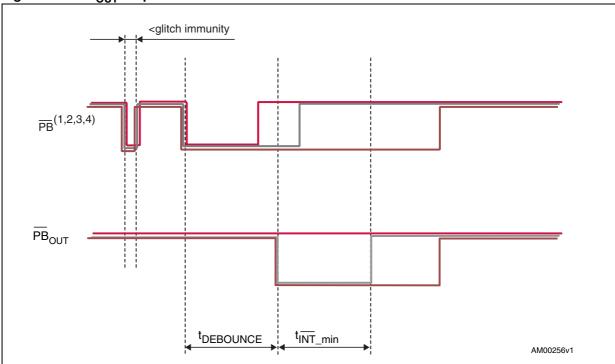
- 1.  $V_{CC}$  goes above  $V_{TH+}$  within  $t_{SRD}$  thus power is not disabled after  $t_{SRD}$  expires.
- 2. t<sub>SRD</sub> period is set by external capacitor C<sub>SRD</sub>.

Figure 21. Undervoltage detected for >t<sub>SRD</sub>



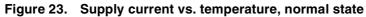
- 1. After  $t_{SRD}$  expires  $V_{CC}$  is still insufficient (below  $V_{TH_+}$ ) thus power is disabled (EN goes low or  $\overline{EN}$  goes high).
- 2. t<sub>SRD</sub> period is set by external capacitor C<sub>SRD</sub>.





- 1. Pulses on  $\overline{PB}$  shorter than glitch immunity are ignored.
- 2. Pulses on  $\overline{PB}$  shorter than  $t_{\mbox{\scriptsize DEBOUNCE}}$  are not recognized by  $\overline{\mbox{\scriptsize PB}}_{\mbox{\scriptsize OUT}}.$
- 3. Minimum pulse width on  $\overline{PB}_{OUT}$  is  $t_{\overline{INT}\_{Min}}$ .
- 4. If push-button is held longer than  $t_{DEBOUNCE} + t_{\overline{INT}\_Min}$ ,  $\overline{PB}_{OUT}$  goes high when the push-button is released.

# 5 Typical operating characteristics



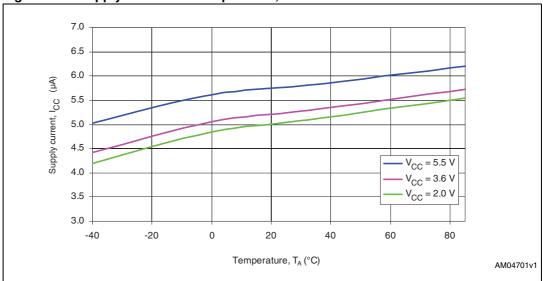
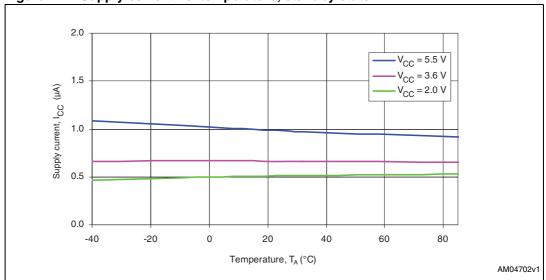


Figure 24. Supply current vs. temperature, standby state



28/51 Doc ID 15453 Rev 7

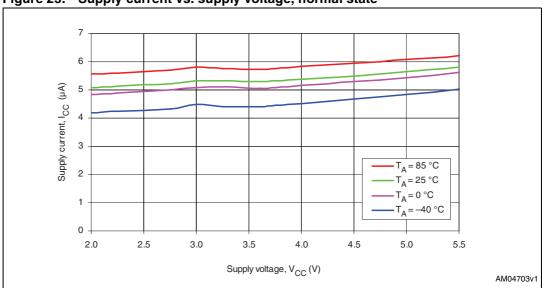
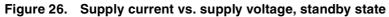
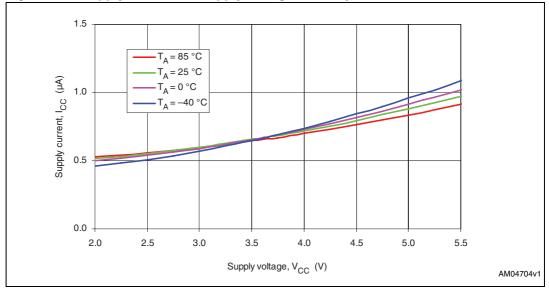


Figure 25. Supply current vs. supply voltage, normal state





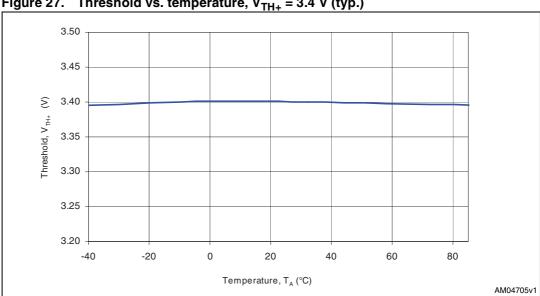
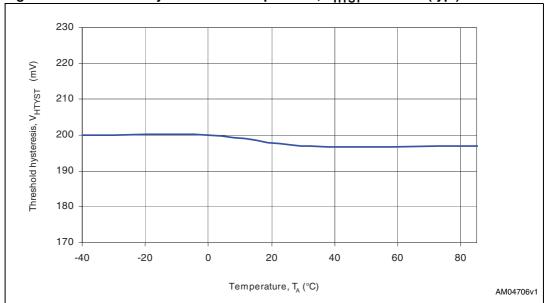


Figure 27. Threshold vs. temperature,  $V_{TH+} = 3.4 \text{ V (typ.)}$ 





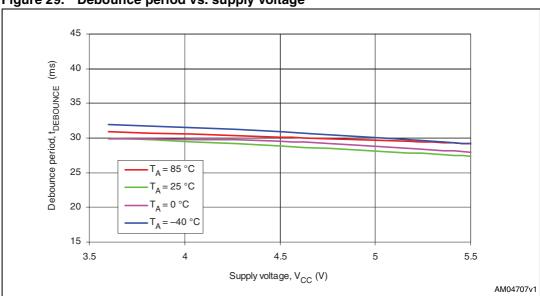
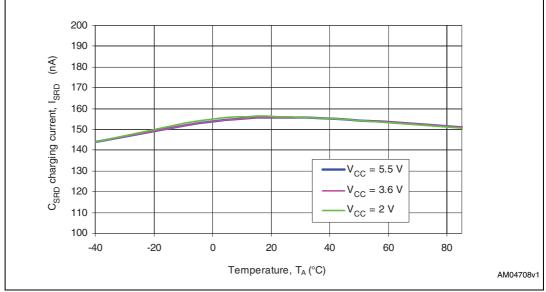


Figure 29. Debounce period vs. supply voltage





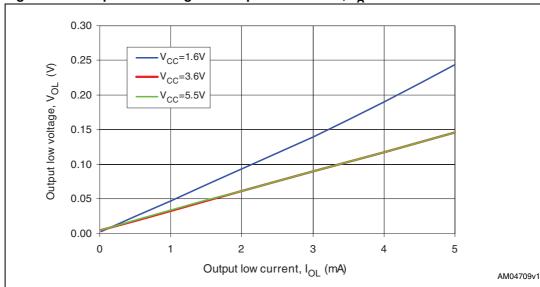
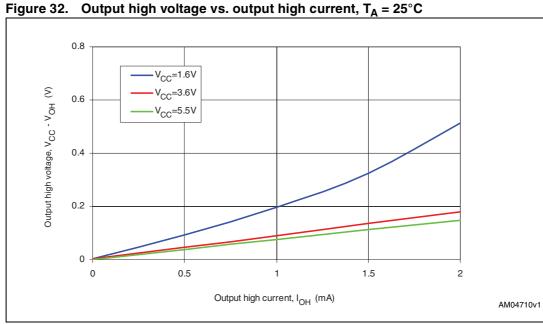


Figure 31. Output low voltage vs. output low current,  $T_A = 25^{\circ}C$ 

Characteristics valid for all the outputs (EN,  $\overline{EN}$ ,  $\overline{RST}$ ,  $\overline{INT}$ ,  $\overline{PB}_{OUT}$  and  $\overline{VCC}_{LO}$ ). Note:



Characteristics valid for EN and EN outputs. Note:

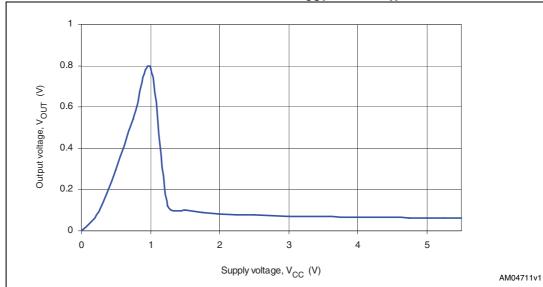


Figure 33. Output voltage vs. supply voltage,  $I_{OUT}$  = 1 mA,  $T_A$  = 25 °C

Note:

Characteristics valid for all the outputs (EN,  $\overline{EN}$ ,  $\overline{RST}$ ,  $\overline{INT}$ ,  $\overline{PB}_{OUT}$  and  $\overline{VCC}_{LO}$ ).

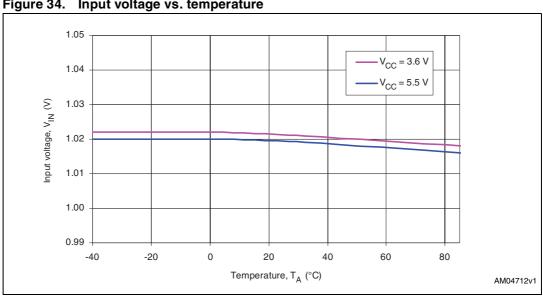


Figure 34. Input voltage vs. temperature

Note:

Characteristics valid for  $\overline{PB}$ ,  $\overline{SR}$  and  $PS_{HOLD}$  inputs.

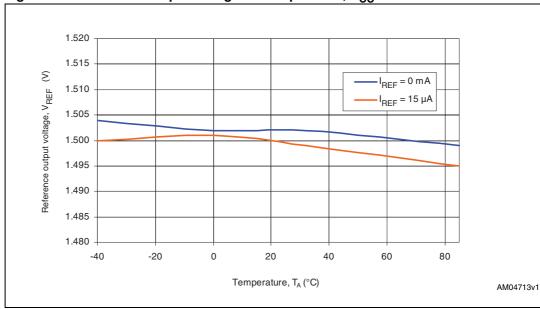
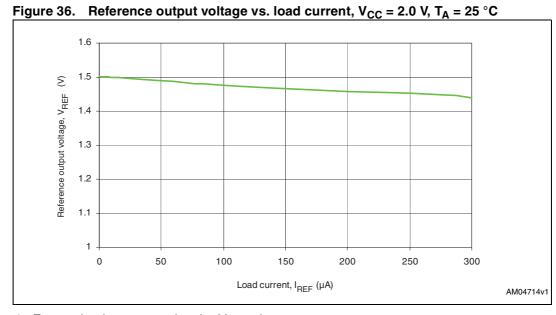


Figure 35. Reference output voltage vs. temperature,  $V_{CC} = 2.0 \text{ V}$ 

Note:

1  $\mu F$  capacitor is connected to the  $V_{REF}$  pin.



Note:

1  $\mu$ F capacitor is connected to the  $V_{REF}$  pin.

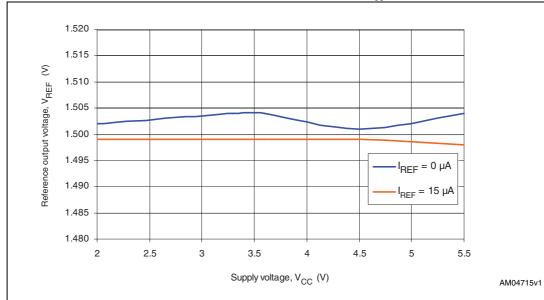


Figure 37. Reference output voltage vs. supply voltage,  $T_A = 25 \, ^{\circ}C$ 

Note:

1  $\mu$ F capacitor is connected to the  $V_{REF}$  pin.

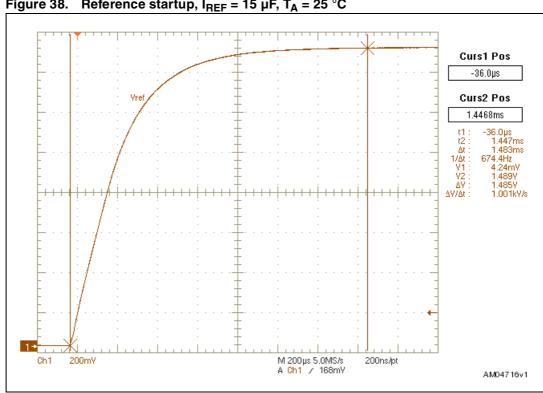


Figure 38. Reference startup,  $I_{REF} = 15 \mu F$ ,  $T_A = 25 °C$ 

Note:

1  $\mu$ F capacitor is connected to the  $V_{REF}$  pin.

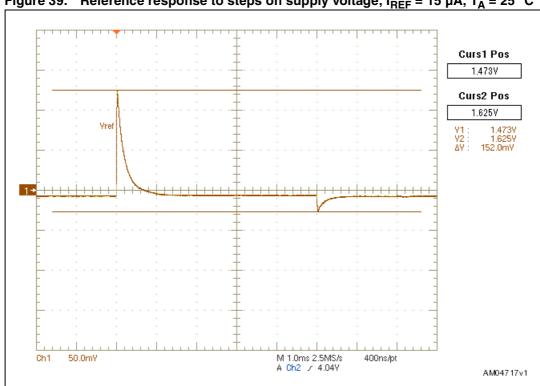


Figure 39. Reference response to steps on supply voltage,  $I_{REF}$  = 15  $\mu$ A,  $T_A$  = 25  $^{\circ}$ C

Supply voltage goes from 3.6 V to 5.5 V and back to 3.6 V, ramp 1 V / 100 ns. Note:

1  $\mu F$  capacitor is connected to the  $V_{REF}$  pin.

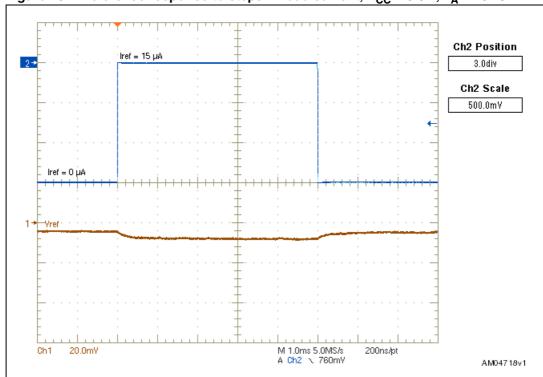


Figure 40. Reference response to steps in load current,  $V_{CC}$  = 3.6 V,  $T_A$  = 25 °C

Note: 1 Supply voltage goes from 0  $\mu$ A to 15  $\mu$ A and back to 0  $\mu$ A, ramp 1  $\mu$ A / 100 ns.

2 1  $\mu$ F capacitor is connected to the  $V_{REF}$  pin.

Maximum ratings STM6600 - STM6601

## 6 Maximum ratings

Stressing the device above the rating listed in the absolute maximum ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 3. Absolute maximum ratings

Symbol	Parameter	Min.	Max.	Unit	Remarks
V <sub>CC</sub>	Input supply voltage	-0.3	+7.0	V	
	Input voltages on $\overline{PB},  \overline{SR},  PS_{HOLD}$ and $C_{SRD}$	-0.3	V <sub>CC</sub> + 0.3	V	
	Output voltages on EN ( $\overline{\text{EN}}$ ), $\overline{\text{RST}}$ and $\overline{\text{INT}}$	-0.3	V <sub>CC</sub> + 0.3	V	
V	Electrostatic protection	-2	+2	kV	Human body model (all pins)
V <sub>ESD</sub>	Electrostatic protection	-8	+8	kV	Human body model (PB and SR)
V <sub>ESD</sub>	Electrostatic protection	-1000	+1000	V	Charged device model
V <sub>ESD</sub>	Electrostatic protection	-200	+200	V	Machine model
V <sub>ESD</sub>	Point discharge on PB and SR inputs	-8	+8	kV	IEC61000-4-2
V <sub>ESD</sub>	Air discharge on $\overline{PB}$ and $\overline{SR}$ inputs	-15	+15	kV	IEC61000-4-2
T <sub>A</sub>	Operating ambient temperature	-40	+85	°C	
T <sub>STG</sub>	Storage temperature	-45	+150	°C	
T <sub>SLD</sub> <sup>(1)</sup>	Lead solder temperature for 10 seconds		+260	°C	
$\theta_{JA}$	Thermal resistance (junction to ambient)		+132.4	°C/W	

<sup>1.</sup> Reflow at peak temperature of 260°C. The time above 255°C must not exceed 30 seconds.

#### 7 DC and AC characteristics

This section summarizes the operating measurement conditions and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics tables that follow are derived from tests performed under the measurement conditions summarized in *Table 4*. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Table 4. Operating and AC measurement conditions

Parameter	Condition	Unit
V <sub>CC</sub> supply voltage	1.6 to 5.5	V
Ambient operating temperature (T <sub>A</sub> )	-40 to 85	°C
Input rise and fall times	≤ 5	ns

Table 5. DC and AC characteristics

Symbol	Parameter	Test condition <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Unit
V <sub>CC</sub>	Supply voltage		1.6		5.5	V
		V <sub>CC</sub> = 3.6 V, no load		6	8	μA
I <sub>CC</sub>	Supply current	Standby mode, enable deasserted, V <sub>CC</sub> = 3.6 V			1	μA
			2.40	2.50	2.60	
	Power-on lockout voltage		3.00	3.10	3.20	
V <sub>TH+</sub>	(see Table 10 for detailed		3.20	3.30	3.40	V
	listing)		3.29	3.40	3.51	
			3.39	3.50	3.61	
V	Threshold hysteresis (see			200		mV
V <sub>HYST</sub>	Table 10 for detailed listing)			500		- IIIV
V <sub>TH</sub> _	Forced power-off voltage (see <i>Table 10</i> for detailed listing)			V <sub>TH+</sub> – V <sub>HYST</sub>		V
t <sub>TH</sub> _	Undervoltage detection to INT delay	V <sub>CC</sub> ≥ 2.0 V	20	32	44	ms
	Blanking period (see		1.4	2.2	3.0	
<sup>t</sup> on_blank	Table 10 for detailed		5.6	8.8	12.0	s
	listing) <sup>(3)</sup>		11.2	17.6	24.0	
	RST assertion to EN (EN) assertion delay during power-up	V <sub>CC</sub> = 3.6 V		100		ns

Table 5. DC and AC characteristics (continued)

Symbol	Parameter	Parameter Test condition <sup>(1)</sup>		Typ. <sup>(2)</sup>	Max.	Unit
PB	<u> </u>	-				
V <sub>IL</sub>	nput low voltage $V_{CC} \ge 2.0 \text{ V}$ , enable asserted				0.99	V
V <sub>IH</sub>	Input high voltage	V <sub>CC</sub> ≥ 2.0 V, enable asserted	1.05			٧
t <sub>DEBOUNCE</sub>	Debounce period	V <sub>CC</sub> ≥ 2.0 V	20	32	44	ms
R <sub>PB</sub>	Internal pull-up resistor	V <sub>CC</sub> = 5.5 V, input asserted	65	100	135	kΩ
SR						
V <sub>IL</sub>	Input low voltage				0.99	V
V <sub>IH</sub>	Input high voltage		1.05			٧
t <sub>DEBOUNCE</sub>	Debounce period		20	32	44	ms
R <sub>SR</sub> <sup>(4)</sup>	Internal pull-up resistor	V <sub>CC</sub> = 5.5 V, input asserted	65	100	135	kΩ
PB <sub>OUT</sub>						
V <sub>OL</sub>	Output low voltage	$\frac{V_{CC}}{PB_{OUT}}$ asserted			0.3	V
	PB <sub>OUT</sub> leakage current	V <sub>PBOUT</sub> = 3 V, <del>PB</del> OUT open drain	-0.1		+0.1	μΑ
VCC <sub>LO</sub>						
V <sub>OL</sub>	Output low voltage	$\frac{V_{CC}}{VCC}$ = 2 V, I <sub>SINK</sub> = 1 mA, $\frac{V_{CC}}{VCC}$ asserted			0.3	V
	VCC <sub>LO</sub> leakage current	V <sub>VCCLO</sub> = 3 V, VCC <sub>LO</sub> open drain	-0.1		+0.1	μΑ
PS <sub>HOLD</sub>						
V <sub>IL</sub>	Input low voltage	V <sub>CC</sub> ≥ 2.0 V			0.99	٧
V <sub>IH</sub>	Input high voltage	V <sub>CC</sub> ≥ 2.0 V	1.05			٧
	Glitch immunity		1	80		μs
	PS <sub>HOLD</sub> leakage current	V <sub>PSHOLD</sub> = 0.6 V	-0.1		0.1	μΑ
	PS <sub>HOLD</sub> to enable propagation delay				30	μs
R <sub>PSHOLD</sub>	Pull-down resistor connected internally during power-up	V <sub>PSHOLD</sub> = 5.5 V	195	300	405	kΩ

Table 5. DC and AC characteristics (continued)

Symbol	Parameter	Test condition <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Unit
C <sub>SRD</sub>			<del>'</del>		•	!
I <sub>SRD</sub>	C <sub>SRD</sub> charging current	nt		150	200	nA
V <sub>SRD</sub>	C <sub>SRD</sub> voltage threshold	$V_{CC}$ = 3.6 V, load on $V_{REF}$ pin 100 kΩ and mandatory 1 μF capacitor, $T_A$ = 25 °C		1.5		V
t <sub>SRD</sub>	Additional Smart Reset <sup>™</sup> delay time	External C <sub>SRD</sub> connected		10		s/µF
EN, EN		•				•
V <sub>OL</sub>	Output low voltage	V <sub>CC</sub> = 2 V, I <sub>SINK</sub> = 1 mA, enable asserted			0.3	V
V <sub>OH</sub> <sup>(5)</sup>	Output high voltage	V <sub>CC</sub> = 2 V, I <sub>SOURCE</sub> = 1 mA, enable asserted	V <sub>CC</sub> - 0.3			V
t <sub>EN_OFF</sub> <sup>(6)</sup>	enable off to enable on	V <sub>CC</sub> ≥ 2.0 V	40	64	88	ms
	EN, EN leakage current	V <sub>EN</sub> = 2 V, enable open drain	-0.1		+0.1	μΑ
RST			1			
V <sub>OL</sub>	Output low voltage	V <sub>CC</sub> = 2 V, I <sub>SINK</sub> = 1 mA, RST asserted			0.3	V
t <sub>REC</sub>	RST pulse width	V <sub>CC</sub> ≥ 2.0 V	240	360	480	ms
	RST leakage current	V <sub>RST</sub> = 3V	-0.1		+0.1	μΑ
ĪNT			1		<b>'</b>	u .
V <sub>OL</sub>	Output low voltage	$\frac{V_{CC}}{INT}$ = 2 V, $I_{SINK}$ = 1 mA,			0.3	V
t <sub>INT_Min</sub>	Minimum INT pulse width	V <sub>CC</sub> ≥ 2.0 V	20	32	44	ms
	INT leakage current	V <sub>INT</sub> = 3 V	-0.1		+0.1	μΑ
V <sub>REF</sub>					•	•
V <sub>REF</sub>	1.5 V voltage reference	$V_{CC}$ = 3.6 V, load on $V_{REF}$ pin 100 kΩ and mandatory 1 μF capacitor, $T_A$ = 25 °C	1.485 -1%	1.5	1.515 +1%	V

- 1. Valid for ambient operating temperature:  $T_A = -40$  to 85 °C;  $V_{CC} = 1.6$  V to 5.5 V (except where noted).
- 2. Typical values are at  $T_A = +25$  °C.
- 3. This blanking time allows the processor to start up correctly (see Figure 7, 8, 9, 10, 11, 12).
- 4. The internal pull-up resistor connected to the  $\overline{\sf SR}$  input is optional (see *Table 10* for detailed device options).
- 5. Valid for push-pull only.
- 6. Minimal delay between enable off and enable on allows the application to power down properly.  $\overline{PB}$  is ignored during this period.

42/51

# 8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Doc ID 15453 Rev 7

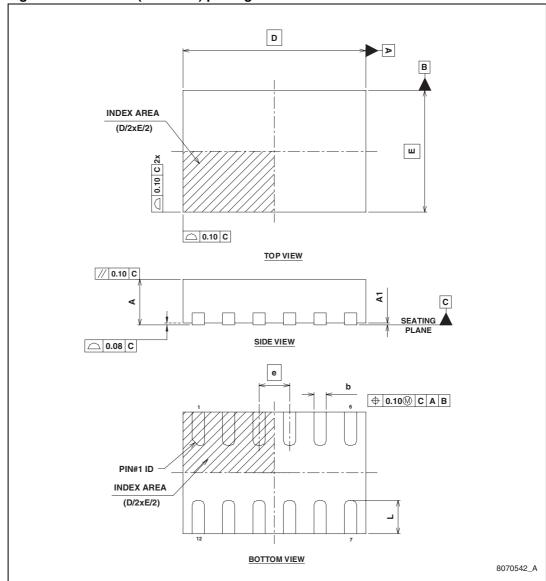


Figure 41. TDFN12 (2 x 3 mm) package outline

Table 6. TDFN12 (2 x 3 mm) package mechanical data

Cymahal		mm		inches				
Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A1	0.00	0.02	0.05	0.000	0.001	0.002		
b	0.15	0.20	0.25	0.006	0.008	0.010		
D		3.00 BSC			0.118			
E		2.00 BSC			0.079			
е		0.50			0.020			
L	0.45	0.55	0.65	0.018	0.022	0.026		

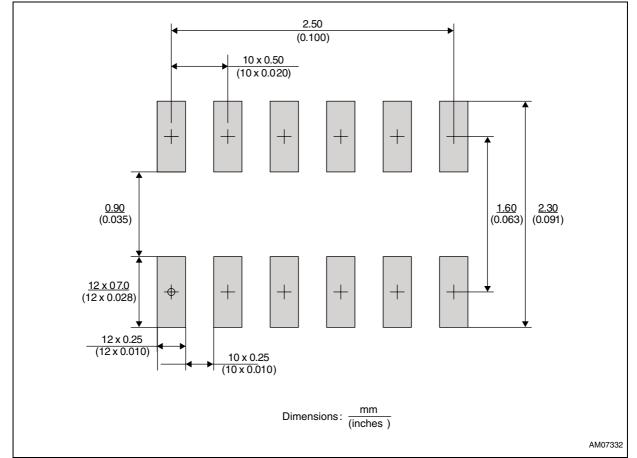


Figure 42. TDFN12 (2 x 3 mm) recommended footprint

Note: Drawing not to scale.

Figure 43. Carrier tape for TDFN12 (2 mm x 3 mm) package

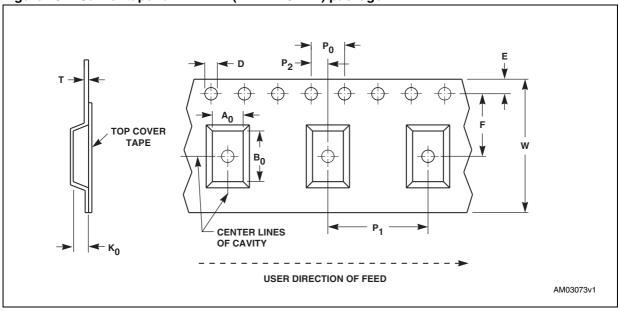
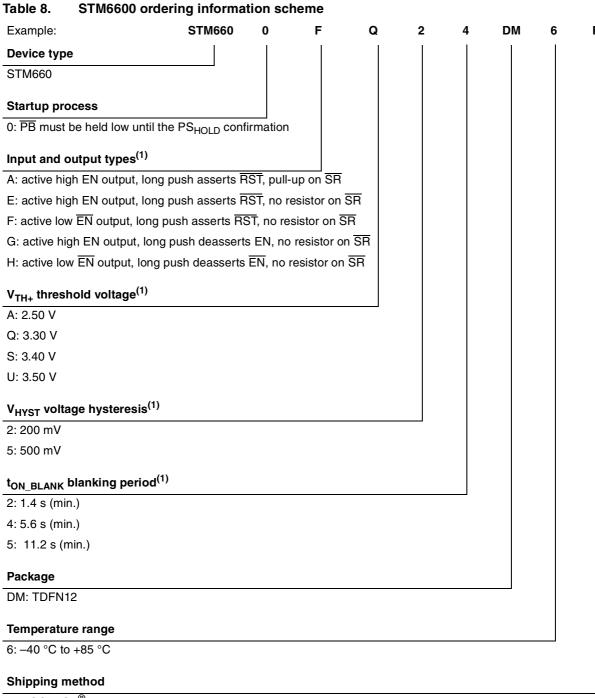


Table 7. Carrier tape dimensions for TDFN12 (2 mm x 3 mm) package

Package	w	D	E	P <sub>0</sub>	P <sub>2</sub>	F	<b>A</b> <sub>0</sub>	B <sub>0</sub>	K <sub>0</sub>	P <sub>1</sub>	Т	Unit	Bulk Qty.
TDFN12	12.00 ±0.30	1.50 +0.10/ -0.00	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	5.50 ±0.05	2.30 ±0.10	3.20 ±0.10	1.10 ±0.01	4.00 ±0.10	0.30 ±0.05	mm	3000

Part numbering STM6600 - STM6601

## 9 Part numbering

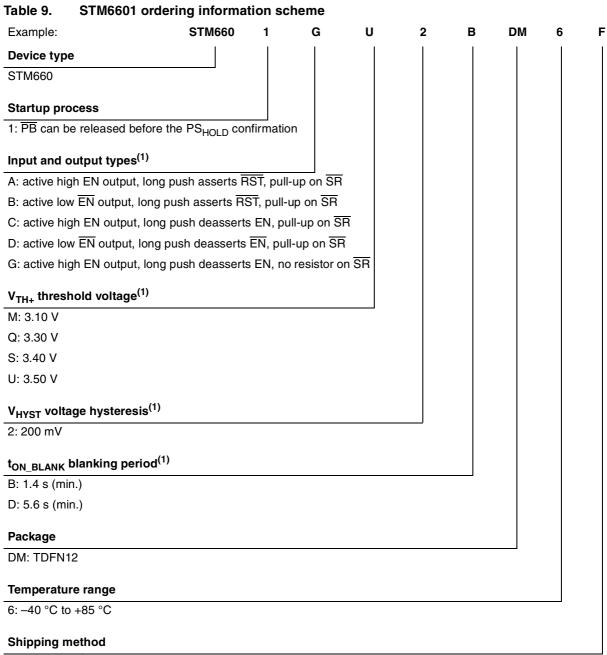


E: ECOPACK® package, tubes

F: ECOPACK® package, tape and reel

1. Other options are offered. Minimum order quantities may apply. Please contact local ST sales office for availability.

STM6600 - STM6601 Part numbering



E: ECOPACK® package, tubes

F: ECOPACK® package, tape and reel

1. Other options are offered. Minimum order quantities may apply. Please contact local ST sales office for availability.

Product selector STM6600 - STM6601

### 10 Product selector

Table 10. STM6600 product selector

Full part number	EN or EN <sup>(1)</sup>	After long push <sup>(2)</sup>	Internal resistor on SR input	Power-on lockout voltage V <sub>TH+</sub> (V)	Forced power-off voltage V <sub>TH-</sub> (V)	t <sub>ON_BLANK</sub> (s) at startup (min.)	t <sub>ON_BLANK</sub> (s) at reset (min.)	Top marking <sup>(3)</sup>
STM6600AS24DM6F	EN	RST	pull-up	3.40	3.20	5.6	5.6	pyww AS24
STM6600ES24DM6F <sup>(4)</sup>	EN	RST	_	3.40	3.20	5.6	5.6	pyww ES24
STM6600FQ24DM6F <sup>(4)</sup>	ĒΝ	RST	_	3.30	3.10	5.6	5.6	pyww FQ24
STM6600GS22DM6F <sup>(4)</sup>	EN	EN	_	3.40	3.20	1.4	_	pyww GS22
STM6600GS25DM6F <sup>(4)</sup>	EN	EN	_	3.40	3.20	11.2	_	pyww GS25
STM6600GU22DM6F <sup>(4)</sup>	EN	EN		3.50	3.30	1.4	_	pyww GU22
STM6600HA55DM6F <sup>(4)</sup>	ĒΝ	ĒN	_	2.50	2.00	11.2	_	pyww HA55
STM6600HQ25DM6F <sup>(4)</sup>	ĒΝ	EN	_	3.30	3.10	11.2	_	pyww HQ25
STM6600HU25DM6F <sup>(4)</sup>	ĒΝ	ĒΝ	_	3.50	3.30	11.2	_	pyww HU25

<sup>1.</sup> EN (or  $\overline{\text{EN}}$ ) output is push-pull.  $\overline{\text{RST}}$ ,  $\overline{\text{INT}}$ ,  $\overline{\text{PB}}_{\text{OUT}}$  and  $\overline{\text{VCC}}_{\text{LO}}$  outputs are open drain.

<sup>2.</sup> After t<sub>SRD</sub> expires through long push, either device reset (RST) will be activated for t<sub>REC</sub> (240 ms min.) or the EN (or EN) pin will be deasserted. The additional Smart Reset delay time, t<sub>SRD</sub>, can be adjusted by the user at 10 s/μF (typ.) by connecting the external capacitor to the C<sub>SRD</sub> pin.

<sup>3.</sup> Where "p" = assembly plant, "y" = assembly year (0 to 9) and "ww" = assembly work week (01 to 52).

<sup>4.</sup> Please contact local ST sales office for availability.

STM6600 - STM6601 Product selector

Table 11. STM6601 product selector

Full part number	EN or EN <sup>(1)</sup>	After long push <sup>(2)</sup>	Internal resistor on SR input	Power-on lockout voltage V <sub>TH+</sub> (V)	Forced power-off voltage V <sub>TH-</sub> (V)	t <sub>ON_BLANK</sub> (s) at startup (min.)	t <sub>ON_BLANK</sub> (s) at reset (min.)	Top marking <sup>(3)</sup>
STM6601AQ2BDM6F	EN	RST	pull-up	3.30	3.10	1.4	1.4	pyww AQ2B
STM6601AU2DDM6F	EN	RST	pull-up	3.50	3.30	5.6	5.6	pyww AU2D
STM6601BM2DDM6F	ĒΝ	RST	pull-up	3.10	2.90	5.6	5.6	pyww BM2D
STM6601BS2BDM6F	EN	RST	pull-up	3.40	3.20	1.4	1.4	pyww BS2B
STM6601CM2DDM6F	EN	EN	pull-up	3.10	2.90	5.6	1	pyww CM2D
STM6601CQ2BDM6F	EN	EN	pull-up	3.30	3.10	1.4	-	pyww CQ2B
STM6601DS2BDM6F	EN	ĒΝ	pull-up	3.40	3.20	1.4	_	pyww DS2B
STM6601GU2BDM6F <sup>(4)</sup>	EN	RST	_	3.50	3.30	5.6	5.6	pyww GU2B

<sup>1.</sup> EN (or  $\overline{\text{EN}}$ ) output is push-pull.  $\overline{\text{RST}}$ ,  $\overline{\text{INT}}$ ,  $\overline{\text{PB}}_{\text{OUT}}$  and  $\overline{\text{VCC}}_{\text{LO}}$  outputs are open drain.

<sup>2.</sup> After t<sub>SRD</sub> expires through long push, either device reset (RST) will be activated for t<sub>REC</sub> (240 ms min.) or the EN (or EN) pin will be deasserted. The additional Smart Reset delay time, t<sub>SRD</sub>, can be adjusted by the user at 10 s/μF (typ.) by connecting the external capacitor to the C<sub>SRD</sub> pin.

<sup>3.</sup> Where "p" = assembly plant, "y" = assembly year (0 to 9) and "ww" = assembly work week (01 to 52).

<sup>4.</sup> Please contact local ST sales office for availability.

Revision history STM6600 - STM6601

# 11 Revision history

Table 12. Document revision history

Date	Revision	Changes
04-Mar-2009	1	Initial release.
05-Jun-2009	2	Updated text in Section 2, Section 3, Figure 11, 12; updated Figure 1, 7, 9, 14, 18, 19, 43, Table 3, 5, 8, 9, 10; added Figure 8, 10, Table 7; reformatted document.
23-Jul-2009	3	Updated text in Features, Table 1, 8, 9, and 10; reformatted document.
22-Oct-2009	4	Updated Section 2, Table 5, Table 10, Figure 1, 7, 8, 9, 10, 11, 12, 14, 18, title of Section 10; added Section 5: Typical operating characteristics (Figure 23 through 40); document status upgraded to full datasheet.
25-Jan-2010	5	Updated <i>Figure 6</i> , <i>Section 2</i> , <i>Table 5</i> ; textual update to "Smart Reset™".
13-Apr-2010	6	Updated Figure 1, 6, 7, 8, 9, 10, 11, 12, 13, Section 2, Section 3, Table 3, 5, 8, 9, 10.
07-Jun-2010	7	Reformatted Figure 1 and Figure 42, corrected typo in Section 3, added option A to Table 8, updated Table 10 and separated Table 10 to Table 10 and Table 11.

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

